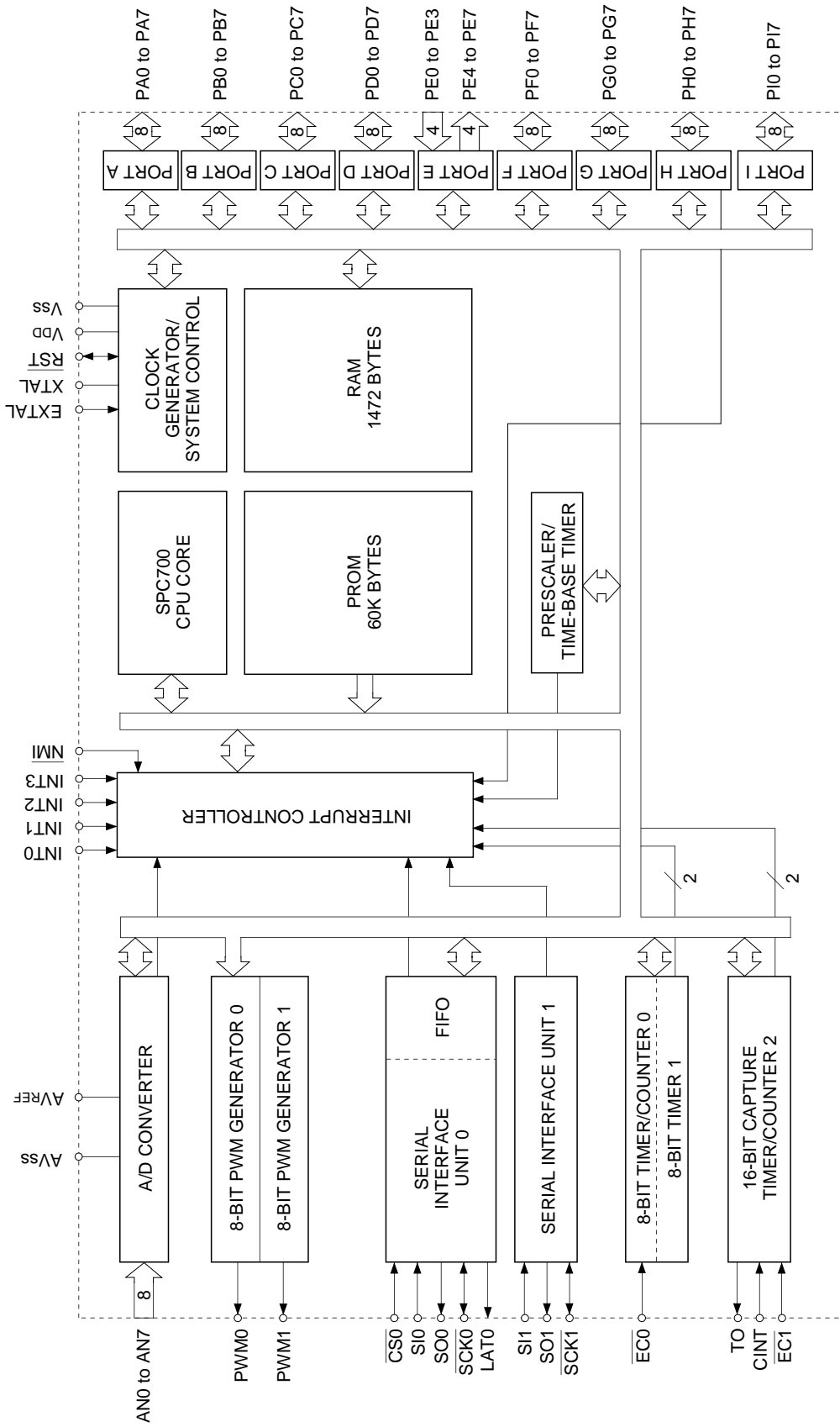
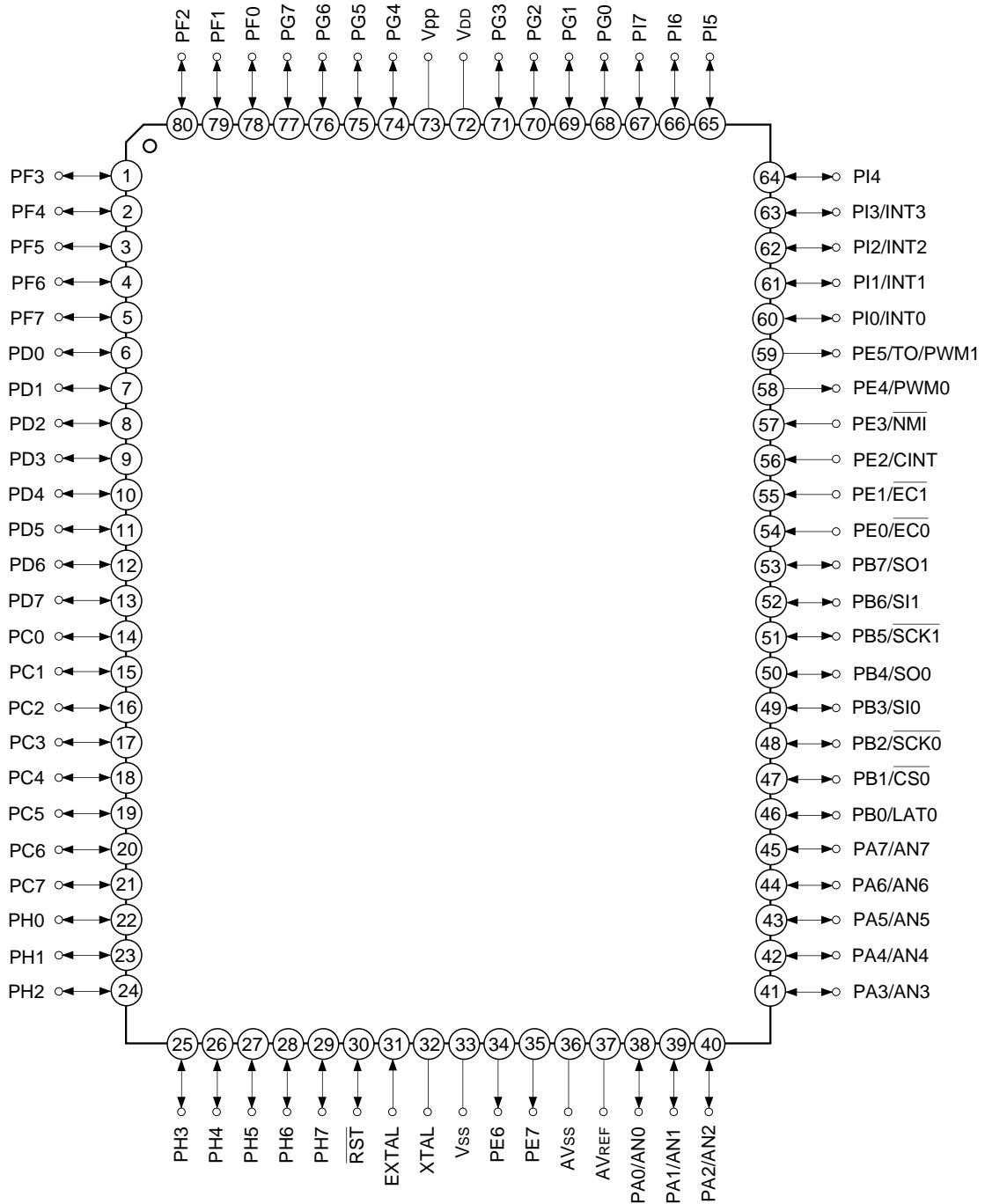


Block Diagram

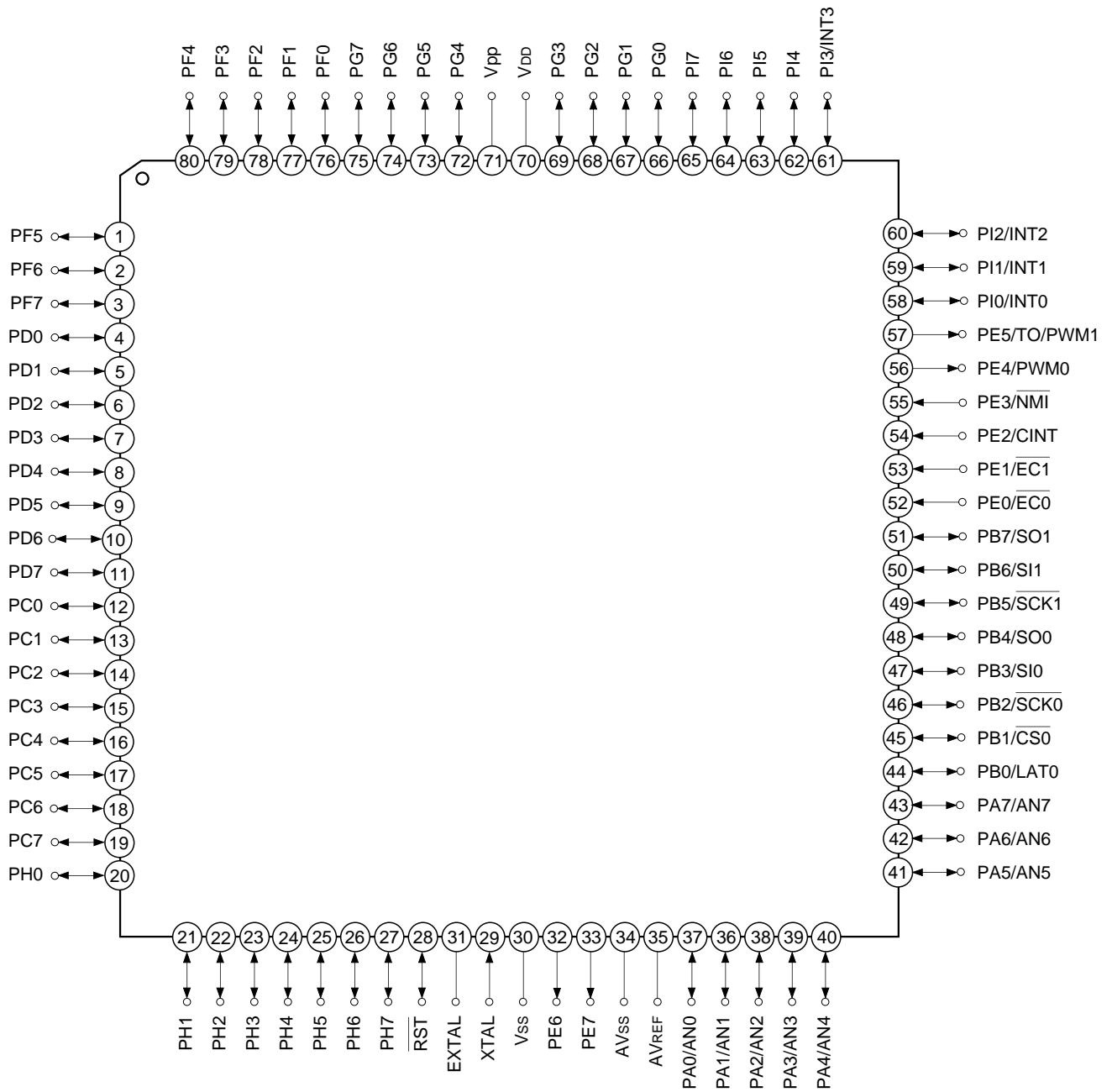


Pin Assignment (Top View) 80-pin QFP package



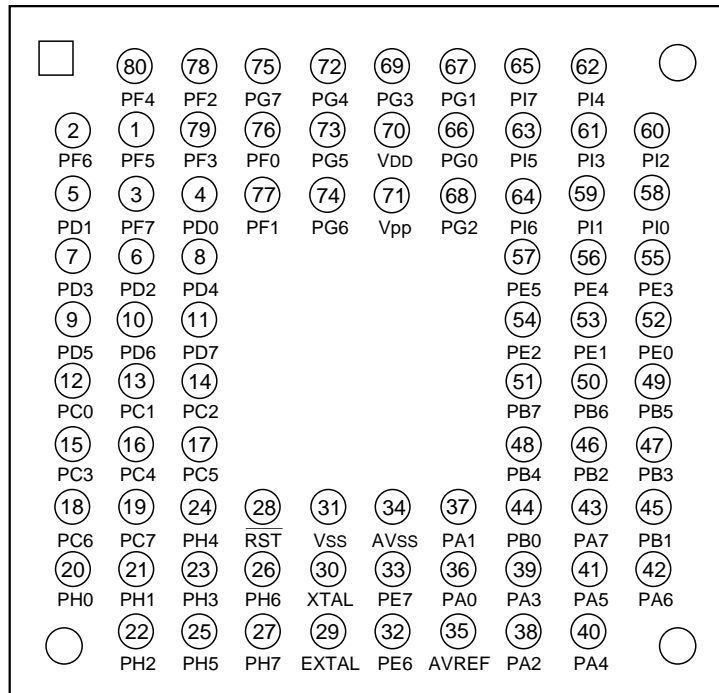
Note) Vpp (Pin 73) should be left open. (Internally connected to VDD.)
 However, this pin is used for the Flash EEPROM-incorporated version (CXP845F60).

Pin Assignment (Top View) 80-pin LQFP package



Note) Vpp (Pin 71) should be left open. (Internally connected to VDD.)
 However, this pin is used for the Flash EEPROM-incorporated version (CXP845F60).

Pin Assignment (Top View) 80-pin LFLGA package



Note) Vpp (Pin 71) should be left open. (Internally connected to VDD.)
 However, this pin is used for the Flash EEPROM-incorporated version (CXP845F60).

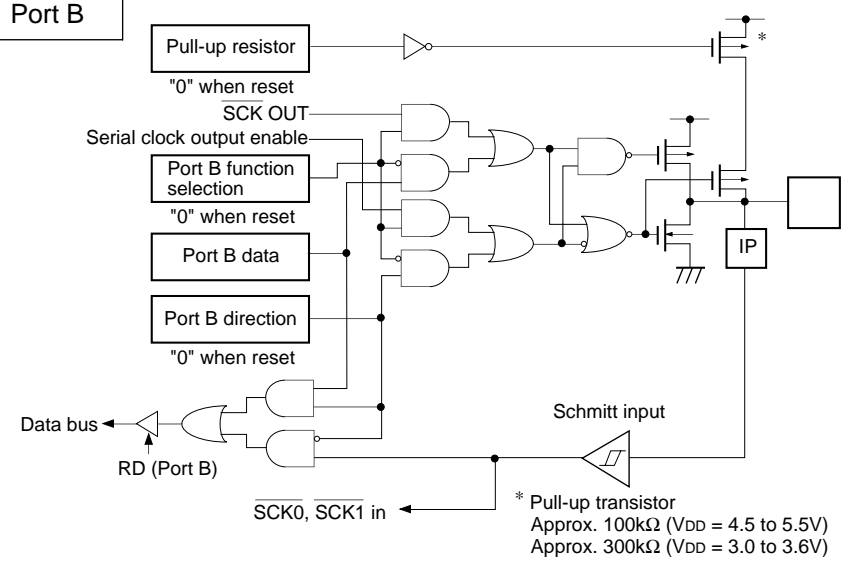
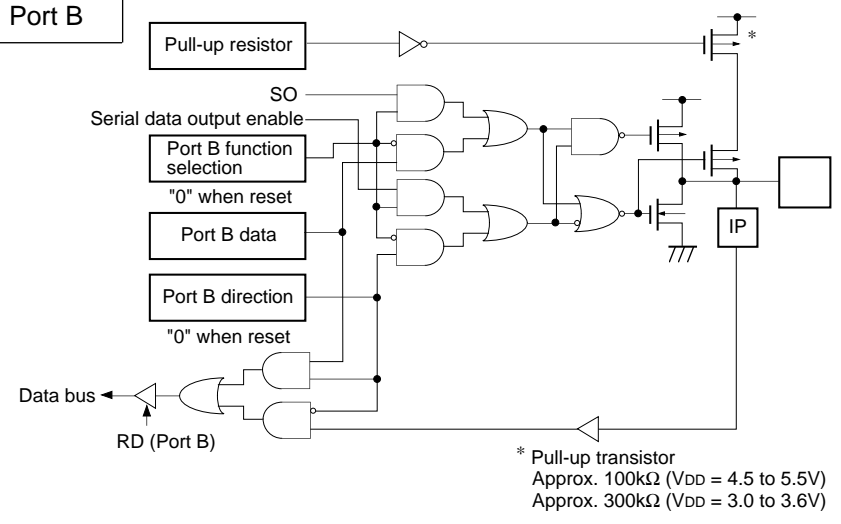
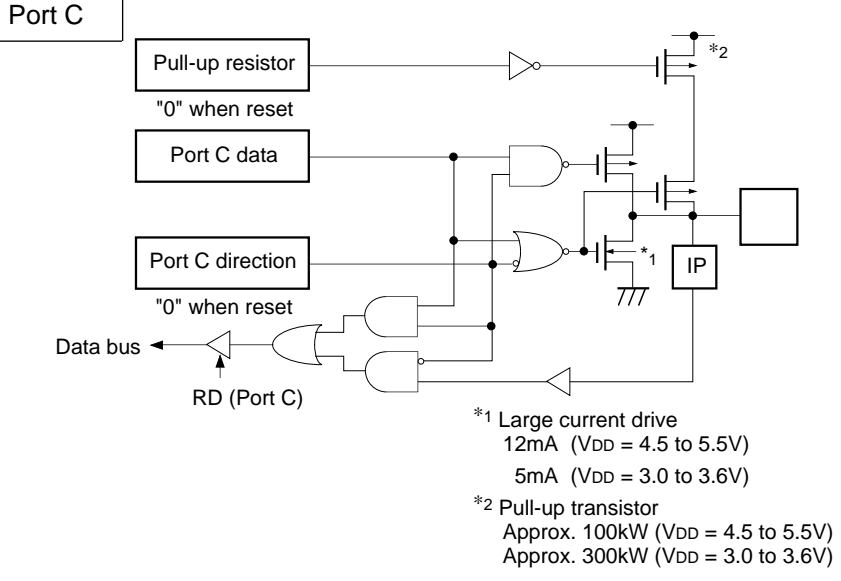
Pin Description

Symbol	I/O	Description	
PA0/AN0 to PA7/AN7	I/O/Analog input	(Port A) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of the pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	Analog inputs to A/D converter. (8 pins)
PB0/LAT0	I/O/Output	(Port B) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	Latch output for serial interface (CH0).
PB1/ $\overline{CS0}$	I/O/Input		Chip select input for serial interface (CH0).
PB2/ $\overline{SCK0}$	I/O/I/O		Serial clock I/O (CH0).
PB3/SI0	I/O/Input		Serial data input (CH0).
PB4/SO0	I/O/Output		Serial data output (CH0).
PB5/ $\overline{SCK1}$	I/O/I/O		Serial clock I/O (CH1).
PB6/SI1	I/O/Input		Serial data input (CH1).
PB7/SO1	I/O/Output		Serial data output (CH1).
PC0 to PC7	I/O	(Port C) 8-bit I/O port. I/O can be set in a unit of single bits. Can drive 12mA sync current. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	
PD0 to PD7	I/O	(Port D) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	
PE0/ $\overline{EC0}$	Input/Input	(Port E) 8-bit port. Lower 4 bits are for inputs; upper 4 bits are for outputs. (8 pins)	External event inputs for timer/counter. (2 pins)
PE1/ $\overline{EC1}$	Input/Input		Capture trigger input.
PE2/CINT	Input/Input		Non-maskable interruption request input.
PE3/ \overline{NMI}	Input/Input		8-bit PWM0 output.
PE4/PWM0	Output/Output		Rectangular wave output for 16-bit timer/counter and 8-bit PWM1 output.
PE5/TO/ PWM1	Output/Output/ Output		
PE6	Output		
PE7	Output		
PF0 to PF7	I/O	(Port F) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	

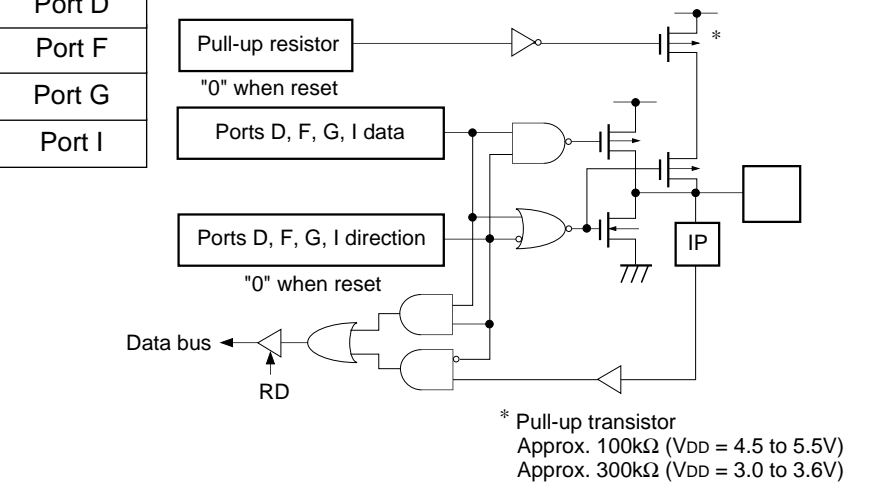
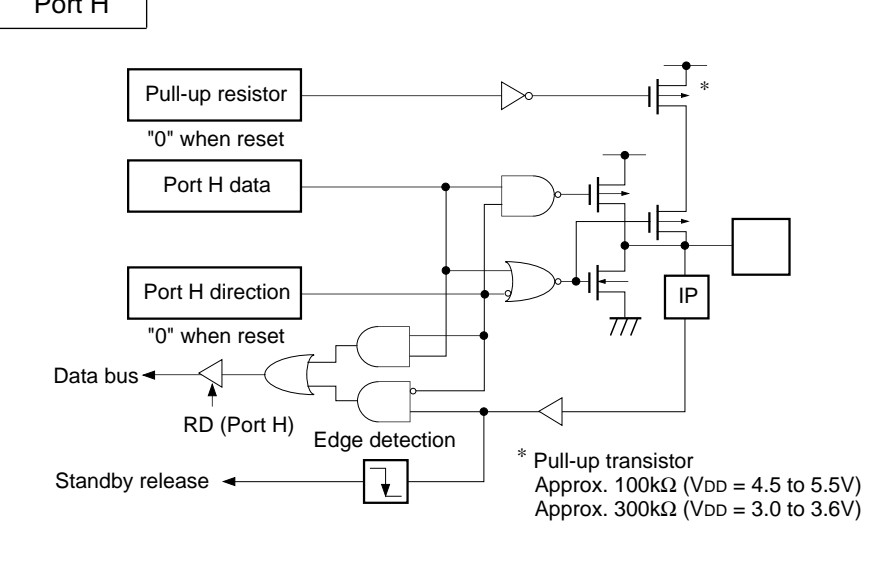
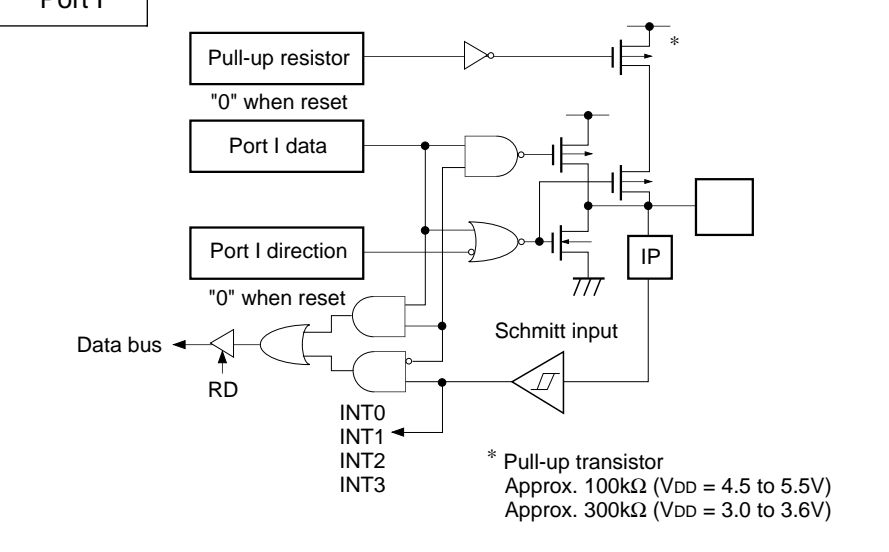
Symbol	I/O	Description	
PG0 to PG7	I/O	(Port G) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	
PH0 to PH7	I/O	(Port H) 8-bit I/O port. I/O and standby release input function can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	
PI0/INT0 to PI3/INT3	I/O/Input	(Port I) 8-bit I/O port. I/O can be set in a unit of single bits. Incorporation of pull-up resistor can be set through the software in a unit of 4 bits. (8 pins)	External interruption request inputs. (4 pins)
PI4 to PI7	I/O		
EXTAL	Input	Connects a crystal for system clock oscillation. When the clock is supplied externally, input to EXTAL; opposite phase clock should be input to XTAL.	
XTAL	Output		
$\overline{\text{RST}}$	I/O	System reset for active at Low level. This pin is I/O pin, and outputs Low level at the power on with the power-on reset function executed.	
Vpp		Positive power supply for incorporated PROM writing. Leave this pin open (internally connected to V _{DD}). This is used for the Flash EEPROM-incorporated version (CXP845F60).	
AVREF	Input	Reference voltage input for A/D converter.	
AVss		A/D converter GND.	
VDD		Positive power supply.	
Vss		GND	

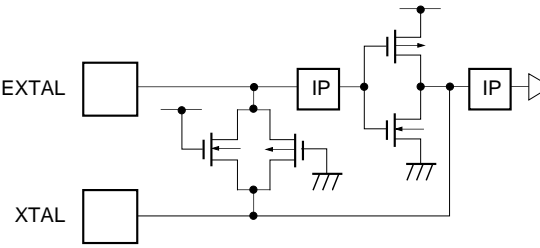
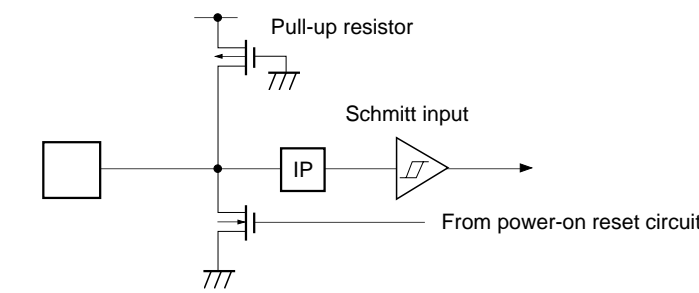
Input/Output Circuit Formats for Pins

Pin	Circuit format	When reset
<p>PA0/AN0 to PA7/AN7</p> <p>8 pins</p>	<p>Port A</p> <p>Pull-up resistor "0" when reset</p> <p>Port A data</p> <p>Port A direction "0" when direction</p> <p>Data bus</p> <p>RD (Port A)</p> <p>Port A function selection "0" when reset</p> <p>Input multiplexer</p> <p>A/D converter</p> <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>
<p>PB0/LAT0</p> <p>1 pin</p>	<p>Port B</p> <p>Pull-up resistor "0" when reset</p> <p>LAT0 Latch output enable</p> <p>Port B data</p> <p>Port B direction "0" when reset</p> <p>Data bus</p> <p>RD (Port B)</p> <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>
<p>PB1/$\overline{\text{CS0}}$ PB3/SI0 PB6/SI1</p> <p>3 pins</p>	<p>Port B</p> <p>Pull-up resistor "0" when reset</p> <p>Port B data</p> <p>Port B direction "0" when reset</p> <p>Data bus</p> <p>RD (Port B)</p> <p>Schmitt input</p> <p>$\overline{\text{CS0}}$ SI0 SI1</p> <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>

Pin	Circuit format	When reset
<p>PB2/SCK0 PB5/SCK1</p> <p>2 pins</p>	<p>Port B</p>  <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>
<p>PB4/SO0 PB7/SO1</p> <p>2 pins</p>	<p>Port B</p>  <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>
<p>PC0 to PC7</p> <p>8 pins</p>	<p>Port C</p>  <p>*1 Large current drive 12mA (V_{DD} = 4.5 to 5.5V) 5mA (V_{DD} = 3.0 to 3.6V)</p> <p>*2 Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>

Pin	Circuit format	When reset
<p>PE0/$\overline{EC0}$ PE1/$\overline{EC1}$ PE2/CINT PE3/\overline{NMI}</p> <p>4 pins</p>	<p>Port E</p> <p>Schmitt input</p> <p>IP</p> <p>$\overline{EC0}, \overline{EC1}$ CINT, \overline{NMI}</p> <p>Data bus</p> <p>RD (Port E)</p>	<p>Hi-Z</p>
<p>PE4/PWM0</p> <p>1 pin</p>	<p>Port E</p> <p>PWM0</p> <p>Port E function selection "0" when reset</p> <p>Port E data "1" when reset</p> <p>Data bus</p> <p>RD (Port E)</p>	<p>High level</p>
<p>PE5/TO/ PWM1</p> <p>1 pin</p>	<p>Port E</p> <p>Internal reset signal</p> <p>Port E data "1" when reset</p> <p>MPX</p> <p>TO 01</p> <p>PWM1 1x</p> <p>Port E function selection (upper)</p> <p>Port E function selection (lower) "00" when reset</p> <p>TO output enable</p> <p>* Pull-up transistor Approx. 150kΩ ($V_{DD} = 4.5$ to 5.5V) Approx. 400kΩ ($V_{DD} = 3.0$ to 3.6V)</p>	<p>High level (with resistor of pull-up transistor ON for reset)</p>
<p>PE6, PE7</p> <p>2 pins</p>	<p>Port E</p> <p>Port E data "0" when reset</p> <p>Data bus</p> <p>RD (Port E)</p>	<p>Low level</p>

Pin	Circuit format	When reset
<p>PD0 to PD7 PF0 to PF7 PG0 to PG7 PI4 to PI7</p> <p>28 pins</p>	<p>Port D Port F Port G Port I</p>  <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>
<p>PH0 to PH7</p> <p>8 pins</p>	<p>Port H</p>  <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>
<p>PI0/INT0 to PI3/INT3</p> <p>4 pins</p>	<p>Port I</p>  <p>* Pull-up transistor Approx. 100kΩ (V_{DD} = 4.5 to 5.5V) Approx. 300kΩ (V_{DD} = 3.0 to 3.6V)</p>	<p>Hi-Z</p>

Pin	Circuit format	When reset
<p>EXTAL XTAL</p> <p>2 pins</p>	 <ul style="list-style-type: none"> • Diagram shows the circuit composition during oscillation. • Feedback resistor is removed during stop mode and XTAL becomes High level. 	<p>Oscillation</p>
<p>$\overline{\text{RST}}$</p> <p>1 pin</p>	 <p>Pull-up resistor</p> <p>Schmitt input</p> <p>From power-on reset circuit</p>	<p>Low level</p>

Absolute Maximum Ratings

(V_{SS} = 0V reference)

Item	Symbol	Ratings	Unit	Remarks
Supply voltage	V _{DD}	-0.3 to +7.0	V	
	AV _{SS}	-0.3 to +0.3	V	
Input voltage	V _{IN}	-0.3 to +7.0* ¹	V	
Output voltage	V _{OUT}	-0.3 to +7.0* ¹	V	
High level output current	I _{OH}	-5	mA	Output (value per pin)
High level total output current	∑I _{OH}	-50	mA	Total for all output pins
Low level output current	I _{OL}	15	mA	All pins excluding large current outputs (value per pin)
	I _{OLC}	20	mA	Large current outputs (value per pin* ²)
Low level total output current	∑I _{OL}	100	mA	Total for all output pins
Operating temperature	T _{opr}	-20 to +75	°C	
Storage temperature	T _{stg}	-55 to +150	°C	
Allowable power dissipation	P _D	600	mW	QFP-80P-L01
		380	mW	LQFP-80P-L01
		500	mW	LFLGA-80P-02

*¹ V_{IN} and V_{OUT} must not exceed V_{DD} + 0.3V.

*² The large current drive transistor is the N-ch transistor of Port C (PC).

Note) Usage exceeding absolute maximum ratings may permanently impair the LSI. Normal operation should be conducted under the recommended operating conditions. Exceeding these conditions may adversely affect the reliability of the LSI.

Recommended Operating Conditions

(V_{SS} = 0V reference)

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage* ¹	V _{DD}	4.5 (3.0)	5.5	V	Guaranteed operation range for 1/2 and 1/4 frequency dividing modes
		3.5 (2.7)	5.5		Guaranteed operation range for 1/16 frequency dividing and sleep modes
		2.0	5.5		Guaranteed data hold range during stop mode
High level input voltage	V _{IH}	0.7V _{DD}	V _{DD}	V	* ²
	V _{IHS}	0.8V _{DD}	V _{DD}	V	Hysteresis input* ³
	V _{IHEX}	0.9V _{DD}	V _{DD} + 0.3	V	EXTAL* ⁴
Low level input voltage	V _{IL}	0	0.3V _{DD}	V	* ²
	V _{ILS}	0	0.2V _{DD}	V	Hysteresis input* ³
	V _{ILEX}	-0.3	0.1V _{DD}	V	EXTAL* ⁴
Operating temperature	T _{opr}	-20	+75	°C	

*¹ Specifies values in parenthesis for 1 to 20MHz system clock operation.

*² Normal input ports (PA, PB0, PB4, PB7, PC, PE0 to PE3, PD, PF to PH, PI4 to PI7)

*³ RST, CINT, CS0, SCK0, SCK1, EC0, EC1, SI0, SI1, NMI, INT0, INT1, INT2, INT3

*⁴ Specifies only during external clock input.

Electrical Characteristics

DC Characteristics ($V_{DD} = 4.5$ to $5.5V$)

($T_a = -20$ to $+75^\circ C$, $V_{SS} = 0V$ reference)

Item	Symbol	Pins	Conditions	Min.	Typ.	Max.	Unit
High level output voltage	V_{OH}	PA to PD, PE4 to PE7, PF to PI, RST (only V_{OL})	$V_{DD} = 4.5V, I_{OH} = -0.5mA$	4.0			V
			$V_{DD} = 4.5V, I_{OH} = -1.2mA$	3.5			V
Low level output voltage	V_{OL}	PA to PD, PE4 to PE7, PF to PI, RST (only V_{OL})	$V_{DD} = 4.5V, I_{OL} = 1.8mA$			0.4	V
			$V_{DD} = 4.5V, I_{OL} = 3.6mA$			0.6	V
		PC	$V_{DD} = 4.5V, I_{OL} = 12.0mA$			1.5	V
Input current	I_{IHE}	EXTAL	$V_{DD} = 5.5V, V_{IH} = 5.5V$	0.1		25	μA
	I_{ILE}		$V_{DD} = 5.5V, V_{IL} = 0.4V$	-0.1		-25	μA
	I_{ILR}	\overline{RST}	$V_{DD} = 5.5V, V_{IL} = 4.0V$	-1.5		-400	μA
	I_{IL}	PA to PD*1 PF to PI*1				-50	μA
				$V_{DD} = 4.5V, V_{IL} = 4.0V$	-2.78		
I/O leakage current	I_{IZ}	PA to PD*1 PF to PI*1 PE0 to PE3	$V_{DD} = 5.5V,$ $V_I = 0, 5.5V$			± 10	μA
Supply current *2	I_{DD1}	V_{DD}	For 1/2 frequency dividing mode		35	64	mA
	I_{DD2}		$V_{DD} = 5.5V, 28MHz$ crystal oscillation ($C_1 = C_2 = 1pF$)				
	I_{DDS1}		Sleep mode		2.5	10	mA
	I_{DDS2}		$V_{DD} = 5.5V, 28MHz$ crystal oscillation ($C_1 = C_2 = 1pF$)				
	I_{DDS3}		Stop mode				
		$V_{DD} = 5.5V, termination of 28MHz$ crystal oscillation			30	μA	
Input capacity	C_{IN}	PA to PD, PE0 to PE3, PF to PI, EXTAL, RST	Clock 1MHz 0V for all pins excluding measured pins		10	20	pF

*1 For PA to PD and PF to PI pins, specifies the input current when pull-up resistance is selected; leakage current when no resistance is selected.

*2 When all pins are open.

DC Characteristics (V_{DD} = 3.0 to 3.6V)

(T_a = -20 to +75°C, V_{SS} = 0V reference)

Item	Symbol	Pins	Conditions	Min.	Typ.	Max.	Unit
High level output voltage	V _{OH}	PA to PD, PE4 to PE7,	V _{DD} = 3.0V, I _{OH} = -0.15mA	2.7			V
			V _{DD} = 3.0V, I _{OH} = -0.5mA	2.3			V
Low level output voltage	V _{OL}	PF to PI, RST (only V _{OL})	V _{DD} = 3.0V, I _{OL} = 1.2mA			0.3	V
			V _{DD} = 3.0V, I _{OL} = 1.6mA			0.5	V
		PC	V _{DD} = 3.0V, I _{OL} = 5mA			1.0	V
Input current	I _{IHE}	EXTAL	V _{DD} = 3.6V, V _{IH} = 3.6V	0.05		15	μA
	I _{ILE}		V _{DD} = 3.6V, V _{IL} = 0.3V	-0.05		-15	μA
	I _{ILR}	RST	V _{DD} = 3.6V, V _{IL} = 0.3V	-0.7		-200	μA
	I _{IIL}	PA to PD* ¹ PF to PI* ¹	V _{DD} = 3.6V, V _{IL} = 0.3V			-30	μA
V _{DD} = 3.0V, V _{IL} = 2.7V			-1.0			μA	
I/O leakage current	I _{Iz}	PA to PD* ¹ PF to PI* ¹ PE0 to PE3	V _{DD} = 3.6V, V _I = 0, 3.6V			±5	μA
Supply current* ²	I _{DD1}	V _{DD}	For 1/2 frequency dividing mode				
	I _{DD2}		V _{DD} = 3.6V, 20MHz crystal oscillation (C ₁ = C ₂ = 10pF)		14.5	30	mA
	I _{DDS1}		Sleep mode				
	I _{DDS2}		V _{DD} = 3.6V, 20MHz crystal oscillation (C ₁ = C ₂ = 10pF)		0.85	4.0	mA
	I _{DDS3}		Stop mode				
V _{DD} = 3.6V, termination of 20MHz crystal oscillation					5	μA	

*¹ For PA to PD and PF to PI pins, specifies the input current when pull-up resistance is selected; leakage current when no resistance is selected.

*² When all pins are open.

AC Characteristics

(1) Clock timing

($T_a = -20$ to $+75^\circ\text{C}$, $V_{DD} = 3.0$ to 5.5V , $V_{SS} = 0\text{V}$ reference)

Item	Symbol	Pin	Conditions	Min.	Typ.	Max.	Unit
System clock frequency	f_c	XTAL EXTAL	Fig. 1, Fig. 2	$V_{DD} = 4.5$ to 5.5V	1	28	MHz
					1	20	
System clock input pulse width	t_{XL} , t_{XH}	EXTAL	Fig. 1, Fig. 2 External clock drive	$V_{DD} = 4.5$ to 5.5V	15.6		ns
					23		
System clock input rise time, fall time	t_{CR} , t_{CF}	EXTAL	Fig. 1, Fig. 2 External clock drive			100	ns
Event count input clock pulse width	t_{EH} , t_{EL}	$\overline{\text{EC0}}$ $\overline{\text{EC1}}$	Fig. 3		$t_{\text{sys}} + 50^{*1}$		ns
Event count input clock rise time, fall time	t_{ER} , t_{EF}	$\overline{\text{EC0}}$ $\overline{\text{EC1}}$	Fig. 3			20	ns

*1 t_{sys} indicates the three values according to the contents of the clock control register (CLC: 00FEh) upper 2 bits (CPU clock selection).

$t_{\text{sys}} [\text{ns}] = 2000/f_c$ (Upper 2 bits = "00"), $4000/f_c$ (Upper 2 bits = "01"), $16000/f_c$ (Upper 2 bits = "11")

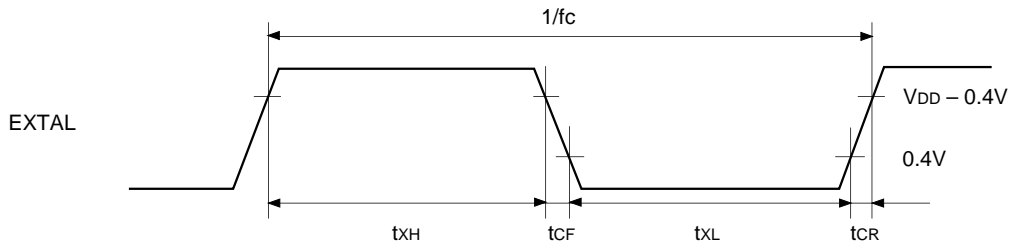


Fig. 1. Clock timing

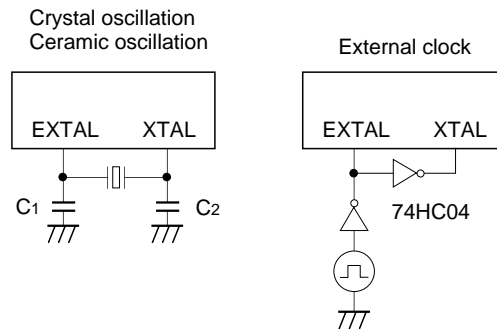


Fig. 2. Clock applied conditions

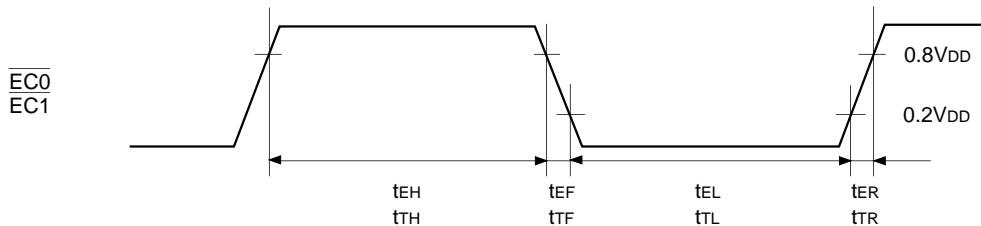


Fig. 3. Event count clock timing

(2) Serial transfer (CH0)

(Ta = -20 to +75°C, V_{DD} = 4.5 to 5.5V, V_{SS} = 0V reference)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
$\overline{CS0} \downarrow \rightarrow \overline{SCK0}$ delay time	t _{DCSK}	$\overline{SCK0}$	Chip select transfer mode ($\overline{SCK0}$ = output mode)		1.5t _{sys} + 100	ns
$\overline{CS0} \uparrow \rightarrow \overline{SCK0}$ float delay time	t _{DCSKF}	$\overline{SCK0}$	Chip select transfer mode ($\overline{SCK0}$ = output mode)		1.5t _{sys} + 100	ns
$\overline{CS0} \downarrow \rightarrow SO0$ delay time	t _{DCSO}	SO0	Chip select transfer mode		1.5t _{sys} + 100	ns
$\overline{CS0} \uparrow \rightarrow SO0$ float delay time	t _{DCSOF}	SO0	Chip select transfer mode		1.5t _{sys} + 100	ns
$\overline{CS0}$ High level width	t _{WHCS}	$\overline{CS0}$	Chip select transfer mode	t _{sys} + 150		ns
$\overline{SCK0}$ cycle time	t _{KCY}	$\overline{SCK0}$	Input mode	2t _{sys} + 200		ns
			Output mode	8000/fc		ns
$\overline{SCK0}$ High, Low level width	t _{KH} t _{KL}	$\overline{SCK0}$	Input mode	t _{sys} + 90		ns
			Output mode	4000/fc - 25		ns
SI0 input setup time (for $\overline{SCK0} \uparrow$)	t _{SIK}	SI0	$\overline{SCK0}$ input mode	50		ns
			$\overline{SCK0}$ output mode	100		ns
SI0 input hold time (for $\overline{SCK0} \uparrow$)	t _{SI}	SI0	$\overline{SCK0}$ input mode	t _{sys} + 100		ns
			$\overline{SCK0}$ output mode	50		ns
$\overline{SCK0} \downarrow \rightarrow SO0$ delay time	t _{KSO}	SO0	$\overline{SCK0}$ input mode		t _{sys} + 100	ns
			$\overline{SCK0}$ output mode		50	ns
$\overline{SCK0} \downarrow \rightarrow LAT0$ output delay time	t _{LADLY}	LAT0	Latch output mode ($\overline{SCK0}$ = output mode)	t _{KCY}	t _{KCY} + 50	ns
LAT0 data pulse width	t _{LAPLS}	LAT0	Latch output mode ($\overline{SCK0}$ = output mode)	t _{KCY} - 10	t _{KCY} + 50	ns

Note 1) t_{sys} indicates the three values according to the contents of the clock control register (CLC: 00FEh) upper 2 bits (CPU clock selection).

t_{sys} [ns] = 2000/fc (Upper 2 bits = "00"), 4000/fc (Upper 2 bits = "01"), 16000/fc (Upper 2 bits = "11")

Note 2) The load condition for the $\overline{SCK0}$ output mode, SO0 output delay time is 50pF + 1TTL.

Serial transfer (CH0)

(Ta = -20 to +75°C, V_{DD} = 3.0 to 3.6V, V_{SS} = 0V reference)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
$\overline{\text{CS0}} \downarrow \rightarrow \overline{\text{SCK0}}$ delay time	t _{DCSK}	$\overline{\text{SCK0}}$	Chip select transfer mode ($\overline{\text{SCK0}}$ = output mode)		1.5t _{sys} + 200	ns
$\overline{\text{CS0}} \uparrow \rightarrow \overline{\text{SCK0}}$ float delay time	t _{DCSKF}	$\overline{\text{SCK0}}$	Chip select transfer mode ($\overline{\text{SCK0}}$ = output mode)		1.5t _{sys} + 200	ns
$\overline{\text{CS0}} \downarrow \rightarrow \text{SO0}$ delay time	t _{DCSO}	SO0	Chip select transfer mode		1.5t _{sys} + 200	ns
$\overline{\text{CS0}} \uparrow \rightarrow \text{SO0}$ float delay time	t _{DCSOF}	SO0	Chip select transfer mode		1.5t _{sys} + 200	ns
$\overline{\text{CS0}}$ High level width	t _{WHCS}	$\overline{\text{CS0}}$	Chip select transfer mode	t _{sys} + 200		ns
$\overline{\text{SCK0}}$ cycle time	t _{KCY}	$\overline{\text{SCK0}}$	Input mode	2t _{sys} + 200		ns
			Output mode	8000/fc		ns
$\overline{\text{SCK0}}$ High, Low level width	t _{KH} t _{KL}	$\overline{\text{SCK0}}$	Input mode	t _{sys} + 80		ns
			Output mode	4000/fc - 50		ns
SI0 input setup time (for $\overline{\text{SCK0}} \uparrow$)	t _{SIK}	SI0	$\overline{\text{SCK0}}$ input mode	80		ns
			$\overline{\text{SCK0}}$ output mode	150		ns
SI0 input hold time (for $\overline{\text{SCK0}} \uparrow$)	t _{SI}	SI0	$\overline{\text{SCK0}}$ input mode	t _{sys} + 120		ns
			$\overline{\text{SCK0}}$ output mode	70		ns
$\overline{\text{SCK0}} \downarrow \rightarrow \text{SO0}$ delay time	t _{KSO}	SO0	$\overline{\text{SCK0}}$ input mode		t _{sys} + 200	ns
			$\overline{\text{SCK0}}$ output mode		80	ns
$\overline{\text{SCK0}} \downarrow \rightarrow \text{LAT0}$ output delay time	t _{LADLY}	LAT0	Latch output mode ($\overline{\text{SCK0}}$ = output mode)	t _{KCY}	t _{KCY} + 100	ns
LAT0 data pulse width	t _{LAPLS}	LAT0	Latch output mode ($\overline{\text{SCK0}}$ = output mode)	t _{KCY} - 10	t _{KCY} + 100	ns

Note 1) t_{sys} indicates the three values according to the contents of the clock control register (CLC: 00FEh) upper 2 bits (CPU clock selection).

t_{sys} [ns] = 2000/fc (Upper 2 bits = "00"), 4000/fc (Upper 2 bits = "01"), 16000/fc (Upper 2 bits = "11")

Note 2) The load condition for the $\overline{\text{SCK0}}$ output mode, SO0 output delay time is 50pF.

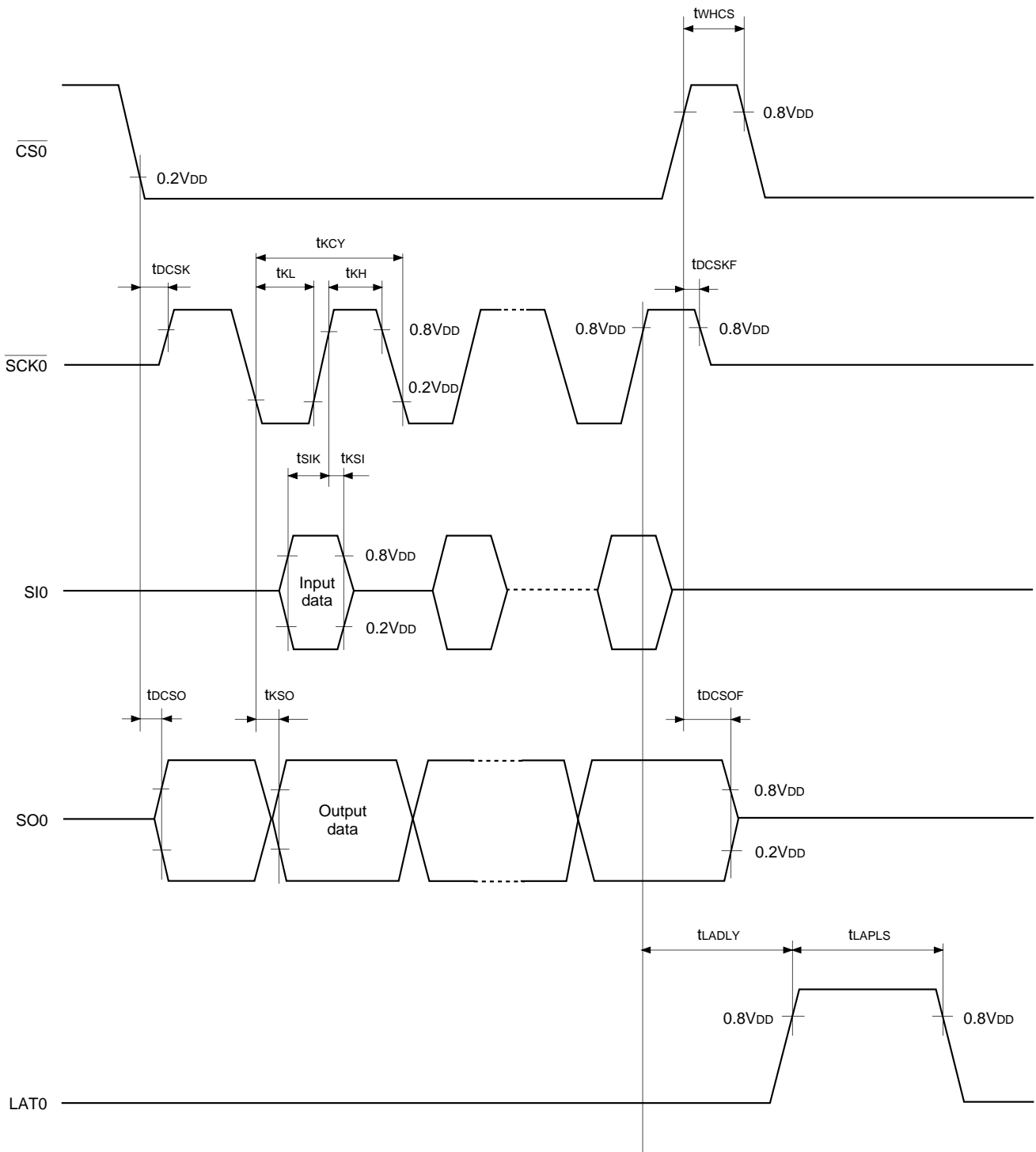


Fig. 4. Serial transfer CH0 timing

(3) Serial transfer (CH1)

(Ta = -20 to +75°C, VDD = 4.5 to 5.5V, VSS = 0V reference)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
$\overline{\text{SCK1}}$ cycle time	t_{KCY}	$\overline{\text{SCK1}}$	Input mode	500		ns
			Output mode	8000/fc		ns
$\overline{\text{SCK1}}$ High, Low level width	t_{KH} t_{KL}	$\overline{\text{SCK1}}$	Input mode	200		ns
			Output mode	4000/fc - 25		ns
SI1 input setup time (for $\overline{\text{SCK1}}$ ↑)	t_{SIK}	SI1	$\overline{\text{SCK1}}$ input mode	50		ns
			$\overline{\text{SCK1}}$ output mode	100		ns
SI1 input hold time (for $\overline{\text{SCK1}}$ ↑)	t_{KSI}	SI1	$\overline{\text{SCK1}}$ input mode	100		ns
			$\overline{\text{SCK1}}$ output mode	50		ns
$\overline{\text{SCK1}}$ ↓ → SO1 delay time	t_{KSO}	SO1	$\overline{\text{SCK1}}$ input mode		100	ns
			$\overline{\text{SCK1}}$ output mode		50	ns

Note) The load condition for the $\overline{\text{SCK1}}$ output mode, SO1 output delay time is 50pF + 1TTL.

(Ta = -20 to +75°C, VDD = 3.0 to 3.6V, VSS = 0V reference)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
$\overline{\text{SCK1}}$ cycle time	t_{KCY}	$\overline{\text{SCK1}}$	Input mode	700		ns
			Output mode	8000/fc		ns
$\overline{\text{SCK1}}$ High, Low level width	t_{KH} t_{KL}	$\overline{\text{SCK1}}$	Input mode	300		ns
			Output mode	4000/fc - 50		ns
SI1 input setup time (for $\overline{\text{SCK1}}$ ↑)	t_{SIK}	SI1	$\overline{\text{SCK1}}$ input mode	70		ns
			$\overline{\text{SCK1}}$ output mode	150		ns
SI1 input hold time (for $\overline{\text{SCK1}}$ ↑)	t_{KSI}	SI1	$\overline{\text{SCK1}}$ input mode	150		ns
			$\overline{\text{SCK1}}$ output mode	70		ns
$\overline{\text{SCK1}}$ ↓ → SO1 delay time	t_{KSO}	SO1	$\overline{\text{SCK1}}$ input mode		150	ns
			$\overline{\text{SCK1}}$ output mode		80	ns

Note) The load condition for the $\overline{\text{SCK1}}$ output mode, SO1 output delay time is 50pF.

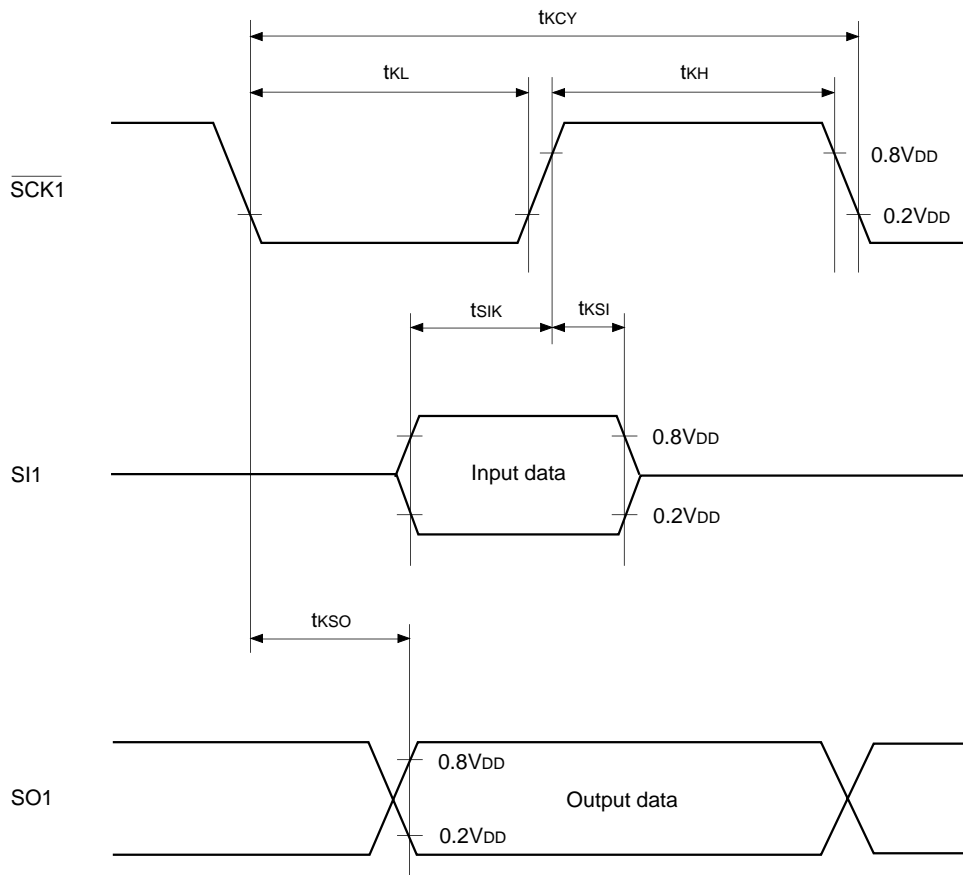


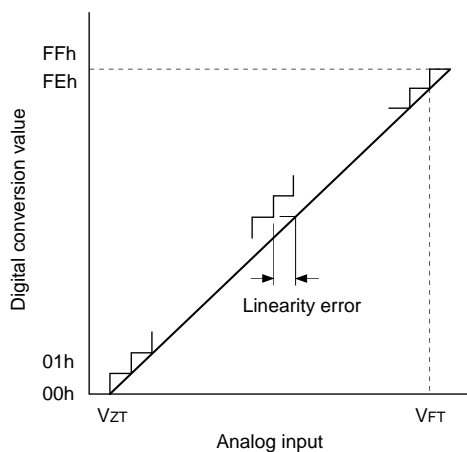
Fig. 5. Serial transfer CH1 timing

(4) A/D converter characteristics (Ta = -20 to +75°C, VDD = 4.5 to 5.5V, AVREF = 4.0 to VDD, VSS = AVSS = 0V reference)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
Resolution						8	Bits
Linearity error			Ta = 25°C VDD = AVREF = 5.0V VSS = AVSS = 0V			±4	LSB
Zero transition voltage	VZT*1			-10	10	70	mV
Full-scale transition voltage	VFT*2			4910	4970	5030	mV
Conversion time	tCONV			27/fADC*3			µs
Sampling time	tSAMP			6/fADC*3			µs
Reference input voltage	VREF	AVREF		VDD - 0.5		VDD	V
Analog input voltage	VIAN	AN0 to AN7		0		AVREF	V
AVREF current	IREF	AVREF	Operation mode		0.6	1.0	mA
	IREFS		Sleep mode Stop mode			10	µA

(Ta = -20 to +75°C, VDD = 3.0 to 3.6V, AVREF = 2.7 to VDD, VSS = AVSS = 0V reference)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
Resolution						8	Bits
Linearity error			Ta = 25°C VDD = AVREF = 3.3V VSS = AVSS = 0V			±5	LSB
Zero transition voltage	VZT*1			-10	6.5	70	mV
Full-scale transition voltage	VFT*2			3216	3280.5	3345	mV
Conversion time	tCONV			27/fADC*3			µs
Sampling time	tSAMP			6/fADC*3			µs
Reference input voltage	VREF	AVREF		VDD - 0.3		VDD	V
Analog input voltage	VIAN	AN0 to AN7		0		AVREF	V
AVREF current	IREF	AVREF	Operation mode		0.4	0.7	mA
	IREFS		Sleep mode Stop mode			5	µA



- *1 VZT: Value at which the digital conversion value changes from 00h to 01h and vice versa.
- *2 VFT: Value at which the digital conversion value changes from FEh to FFh and vice versa.
- *3 fADC indicates the values below due to the contents of bit 6 (CKS) of the A/D control register (ADC: 00F9h).
 $f_{ADC} = f_c$ (CKS = "0"), $f_c/2$ (CKS = "1")
 However, the selection for $f_{ADC} = f_c$ (CKS = "0") is limited in the clock range of $f_c = 1$ to 14MHz (VDD 4.5 to 5.5V) and $f_c = 1$ to 10MHz (VDD = 3.0 to 4.5V).

Fig. 6. Definition of A/D converter terms

(5) Interruption, reset input (Ta = -20 to +75°C, VDD = 3.0 to 5.5V, VSS = 0V reference)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
External interruption High, Low level width	t _{IH}	INT0 INT1 INT2 INT3 $\overline{\text{NMI}}$		1		μs
	t _{IL}					
Reset input Low level width	t _{RSL}	$\overline{\text{RST}}$		32/fc		μs

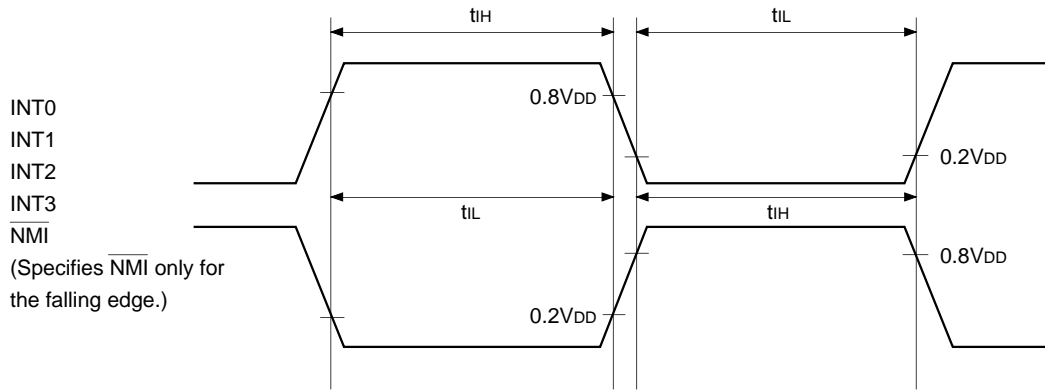


Fig 7. Interruption input timing

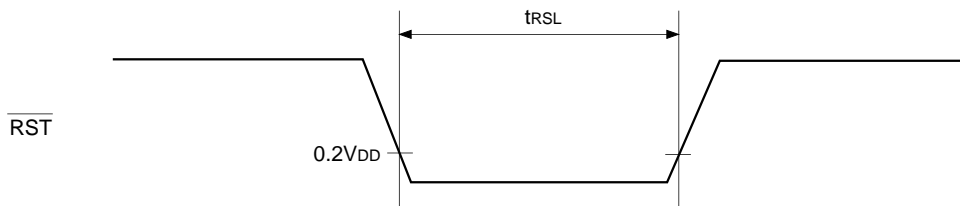
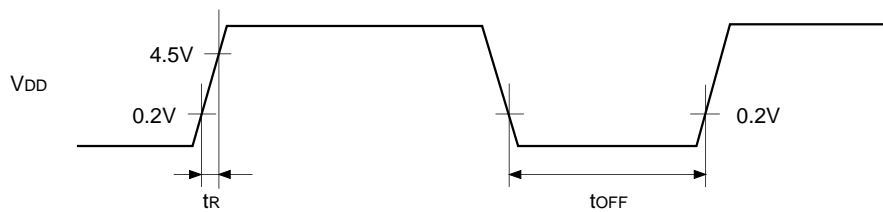


Fig. 8. $\overline{\text{RST}}$ input timing

(6) Power-on reset (Ta = -20 to +75°C, VDD = 4.5 to 5.5V, VSS = 0V reference)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
Power supply rise time	t _R	VDD	Power-on reset	0.05	50	ms
Power supply cut-off time	t _{OFF}		Repetitive power-on reset	1		ms



Turn the power on smoothly.

Fig. 9. Power-on reset

Appendix

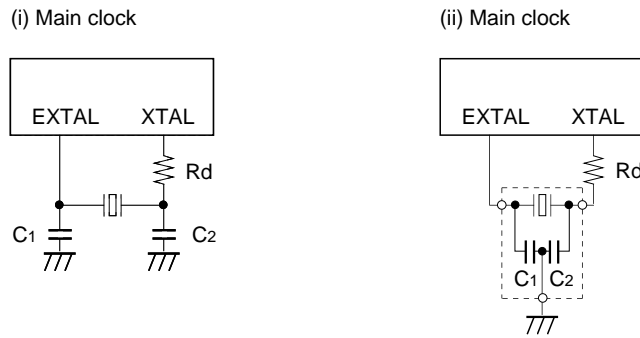


Fig. 10. SPC700 Series recommended oscillation circuit

Manufacturer	Model	fc (MHz)	C1 (pF)	C2 (pF)	Rd (Ω)	Circuit example				
MURATA MFG CO., LTD.	CSA8.00MTZ	8.00	30	30	0	(i)				
	CSA10.0MTZ	10.00								
	CSA12.00MTZ	12.00								
	CST8.00MTW*	8.00					(ii)			
	CST10.0MT*	10.00								
	CST12.0MTW*	12.00								
	CSA16.00MXZ040	16.00				5		5	0	(i)
	CST16.00MXZ0C1*	16.00				5		5	0	(ii)
	CSA20.00MXZ040	20.00				OPEN		OPEN	0	(i)
	CSA24.00MXZ040	24.00				3	3	0		
CSA28.00MXZ040	28.00	3	3	0						
TDK CORPORATION.	CCR20.0MC6*	20.00	16	16	0	(ii)				
	CCR24.0MC6*	24.00	16	16	0					
KINSEKI LTD.	HC49/U-S	28.00	1	1	220	(i)				
	CX-11F	28.00	1	1	220					

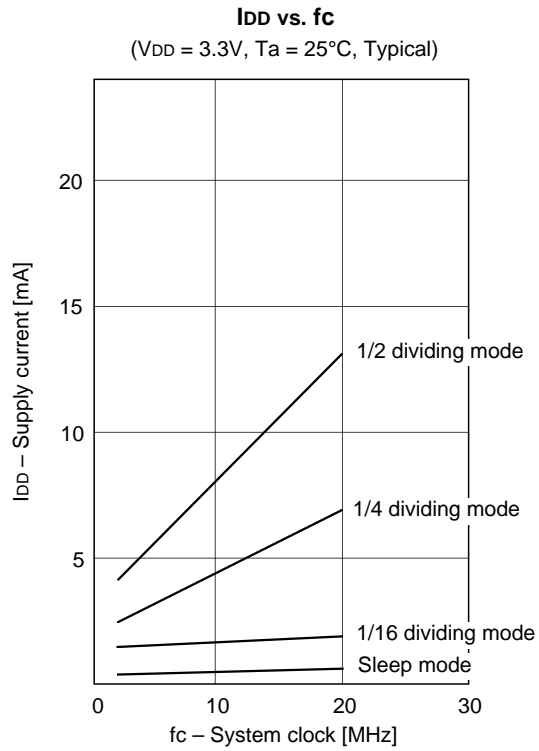
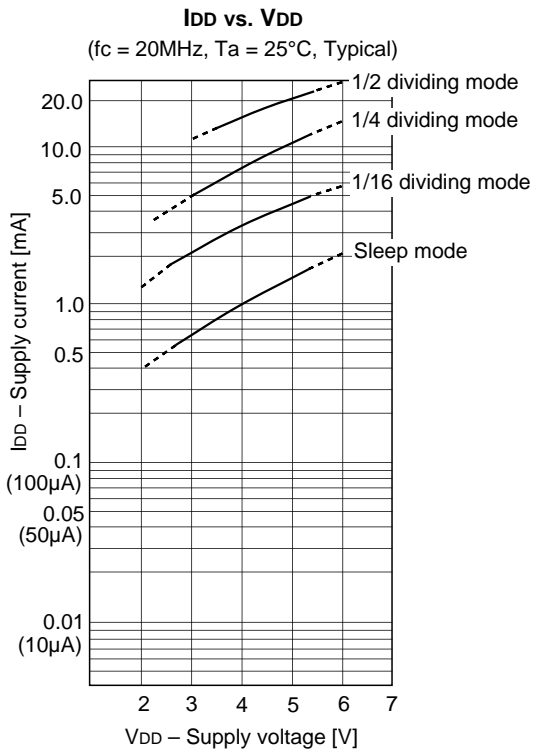
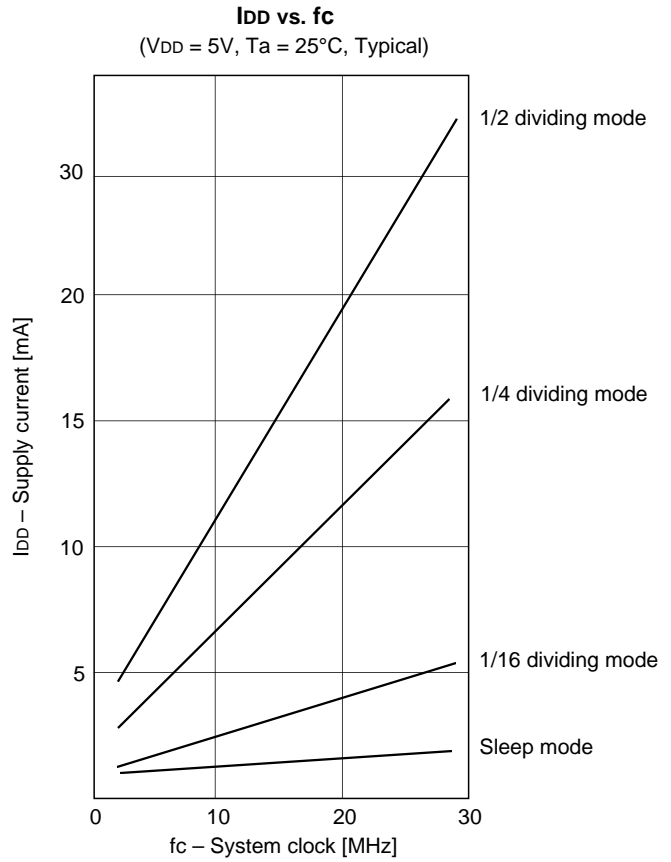
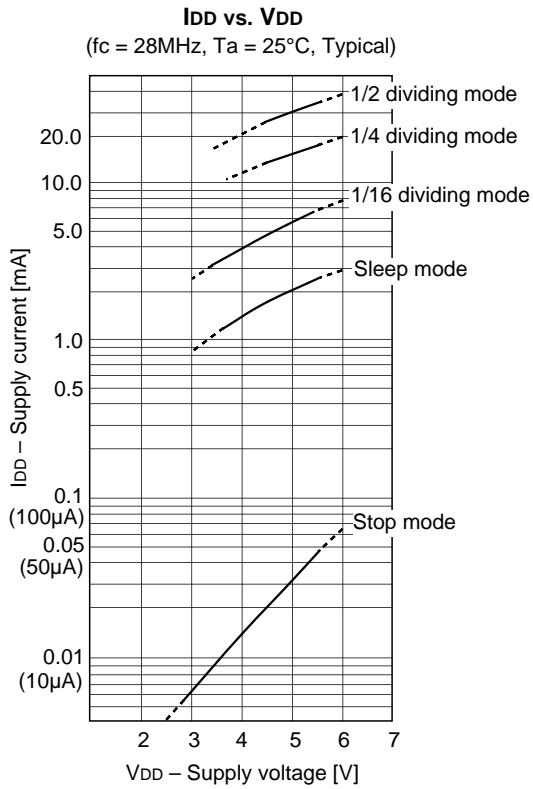
Models with an asterisk (*) have the built-in ground capacitance (C1, C2).

Selection Guide

Option item	Mask		OTP		
Product name	CXP84540	CXP84548	CXP845P60Q-1-□□□	CXP845P60R-1-□□□	CXP845P60GA-1-□□□
Package	80-pin plastic QFP/LQFP/LFLGA		80-pin plastic QFP	80-pin plastic LQFP	80-pin plastic LFLGA
ROM capacitance	40K bytes	48K bytes	PROM 60K bytes		
Reset pin pull-up resistor	Existent/Non-existent		Existent		
Power-on reset function*1	Existent/Non-existent		Existent		

*1 When the OTP product with the power-on reset function is used outside the range of V_{DD} = 4.5 to 5.5V, be sure to keep the external reset (setting the $\overline{\text{RST}}$ pin to Low) for the oscillation stable time or more.

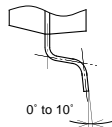
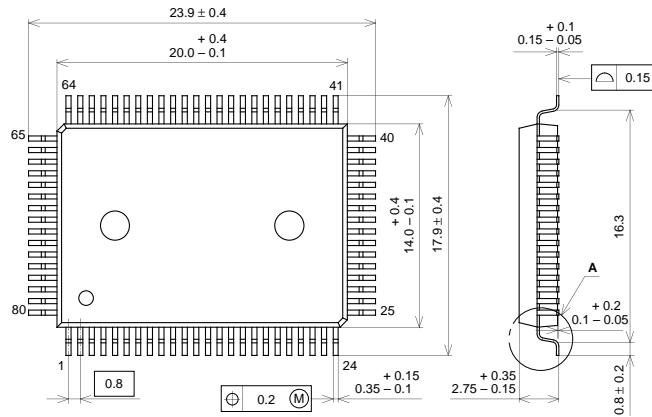
Characteristics Curves



Package Outline

Unit: mm

80PIN QFP (PLASTIC)



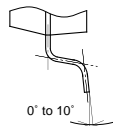
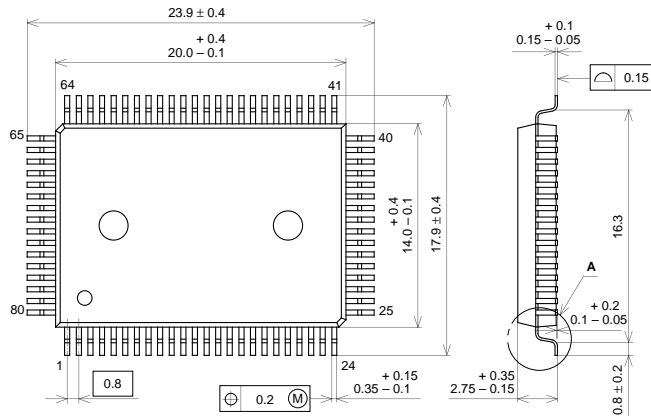
DETAIL A

PACKAGE STRUCTURE

SONY CODE	QFP-80P-L01
EIAJ CODE	QFP080-P-1420
JEDEC CODE	

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	1.6g

80PIN QFP (PLASTIC)



DETAIL A

PACKAGE STRUCTURE

SONY CODE	QFP-80P-L01
EIAJ CODE	QFP080-P-1420
JEDEC CODE	

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	1.6g

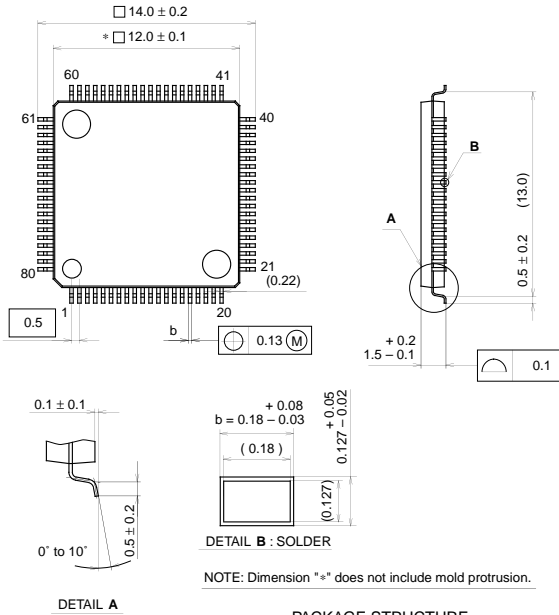
LEAD PLATING SPECIFICATIONS

ITEM	SPEC.
LEAD MATERIAL	42 ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18μm

Package Outline

Unit: mm

80PIN LQFP (PLASTIC)

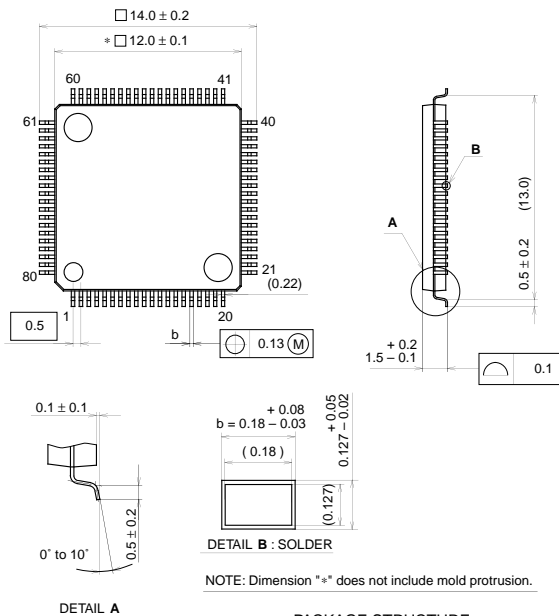


PACKAGE STRUCTURE

SONY CODE	LQFP-80P-L01
EIAJ CODE	P-LQFP80-12x12-0.5
JEDEC CODE	

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42 / COPPER ALLOY
PACKAGE MASS	0.5g

80PIN LQFP (PLASTIC)



PACKAGE STRUCTURE

SONY CODE	LQFP-80P-L01
EIAJ CODE	P-LQFP80-12x12-0.5
JEDEC CODE	

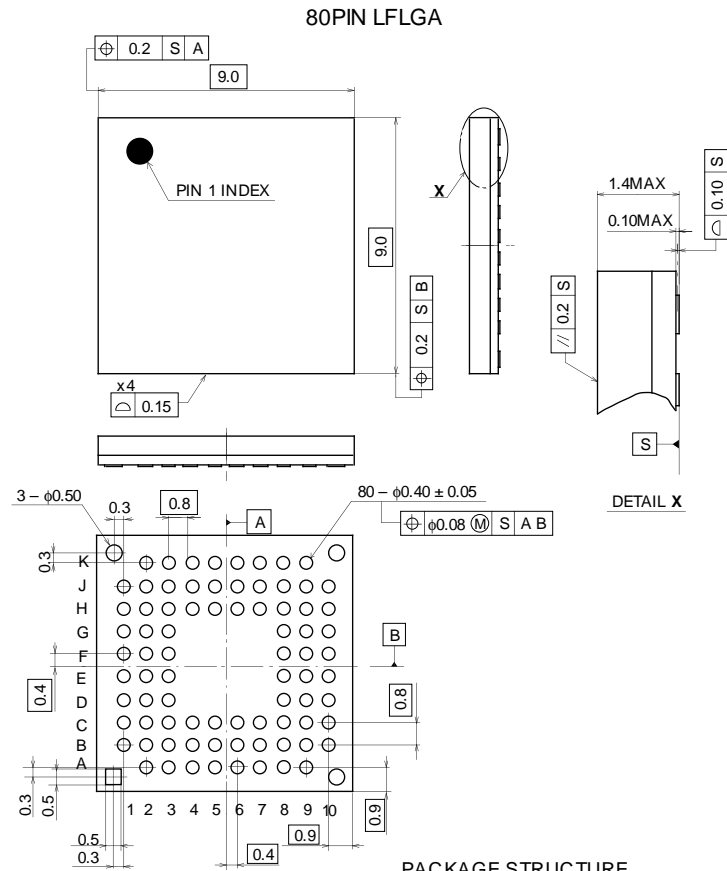
PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42 / COPPER ALLOY
PACKAGE MASS	0.5g

LEAD PLATING SPECIFICATIONS

ITEM	SPEC.
LEAD MATERIAL	42 ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18 μ m

Package Outline

Unit: mm



PACKAGE STRUCTURE

SONY CODE	LFLGA-80P-02
EIAJ CODE	P-LFLGA80-9x9-0.8
JEDEC CODE	—

PACKAGE MATERIAL	ORGANIC SUBSTRATE
TERMINAL TREATMENT	GOLD PLATING
TERMINAL MATERIAL	NICKEL PLATING
PACKAGE MASS	0.3g



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

LittleDiode.com

Looking forward to providing you with the best possible service.